



SamHop Microelectronics Corp.

STM4460

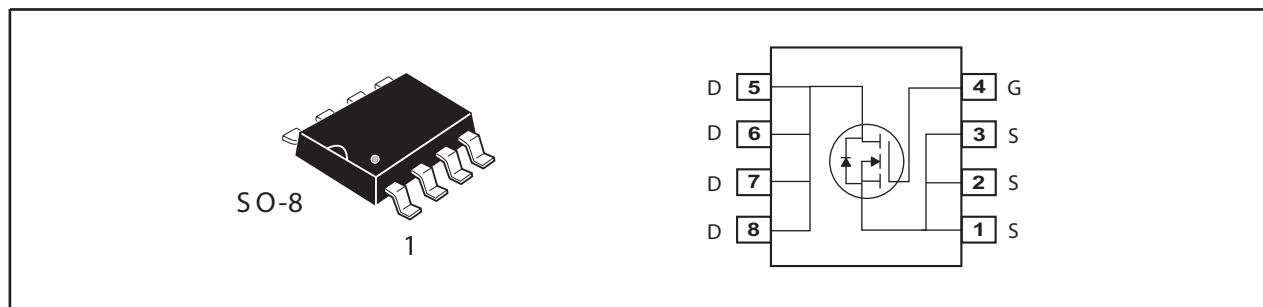
Ver 1.0

N-Channel Enhancement Mode Field Effect Transistor

PRODUCT SUMMARY		
V _{DSS}	I _D	R _{DSON} (mΩ) Max
40V	7A	32 @ V _{GS} =10V
		45 @ V _{GS} =4.5V

FEATURES

- Super high dense cell design for low R_{DSON}.
- Rugged and reliable.
- Surface Mount Package.



ABSOLUTE MAXIMUM RATINGS (T_A=25°C unless otherwise noted)

Symbol	Parameter		Limit	Units
V _{DS}	Drain-Source Voltage		40	V
V _{GS}	Gate-Source Voltage		±20	V
I _D	Drain Current-Continuous ^a	T _A =25°C	7	A
		T _A =70°C	5.6	A
I _{DM}	-Pulsed ^b		28	A
E _{AS}	Single Pulse Avalanche Energy ^d		9	mJ
P _D	Maximum Power Dissipation ^a	T _A =25°C	2.5	W
		T _A =70°C	1.6	W
T _J , T _{STG}	Operating Junction and Storage Temperature Range		-55 to 150	°C

THERMAL CHARACTERISTICS

R _{θ JA}	Thermal Resistance, Junction-to-Ambient ^a	50	°C/W
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Details are subject to change without notice.

Jun,18,2008

STM4460

Ver 1.0

ELECTRICAL CHARACTERISTICS (TA=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	40			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =32V , V _{GS} =0V			1	uA
I _{GSS}	Gate-Body Leakage Current	V _{GS} = ±20V , V _{DS} =0V			±100	nA
ON CHARACTERISTICS						
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250uA	1	1.9	3	V
R _{D(S)} (ON)	Drain-Source On-State Resistance	V _{GS} =10V , I _D =7A		26	32	m ohm
		V _{GS} =4.5V , I _D =6A		33	45	m ohm
g _{FS}	Forward Transconductance	V _{DS} =10V , I _D =7A		16		S
DYNAMIC CHARACTERISTICS ^c						
C _{ISS}	Input Capacitance	V _{DS} =20V,V _{GS} =0V f=1.0MHz		635		pF
C _{OSS}	Output Capacitance			95		pF
C _{RSS}	Reverse Transfer Capacitance			55		pF
SWITCHING CHARACTERISTICS ^c						
t _{D(ON)}	Turn-On Delay Time	V _{DD} =20V I _D =7A V _{GS} =10V R _{GEN} =3.3 ohm		11		ns
t _r	Rise Time			12		ns
t _{D(OFF)}	Turn-Off Delay Time			17		ns
t _f	Fall Time			11		ns
Q _g	Total Gate Charge	V _{DS} =20V,I _D =7A,V _{GS} =10V		11		nC
		V _{DS} =20V,I _D =6A,V _{GS} =4.5V		5.1		nC
Q _{gs}	Gate-Source Charge	V _{DS} =20V,I _D =7A, V _{GS} =10V		1.7		nC
Q _{gd}	Gate-Drain Charge			3		nC
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
I _s	Maximum Continuous Drain-Source Diode Forward Current			7		A
V _{SD}	Diode Forward Voltage	V _{GS} =0V,I _s =7A		0.98	1.3	V
Notes						
a.Surface Mounted on FR4 Board,t ≤ 10sec.						
b.Pulse Test:Pulse Width ≤ 300us, Duty Cycle ≤ 2%.						
c.Guaranteed by design, not subject to production testing.						
d.Starting T _J =25°C,L=0.5mH,R _G =25Ω,V _{DD} =20V.(See Figure13)						

Jun,18,2008

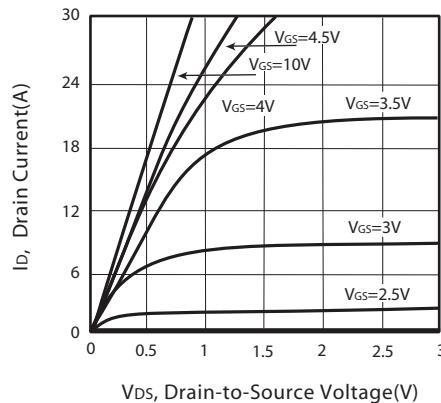


Figure 1. Output Characteristics

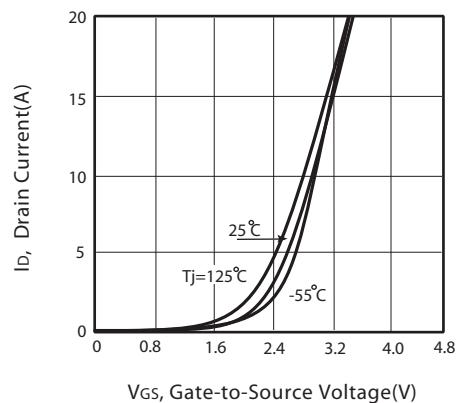


Figure 2. Transfer Characteristics

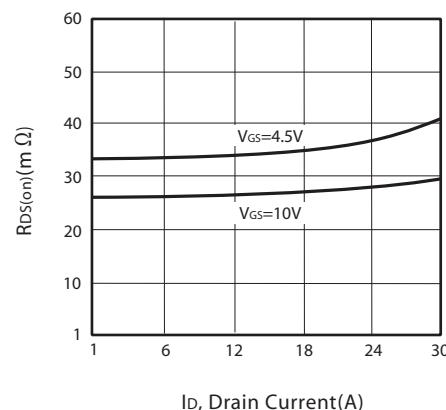


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

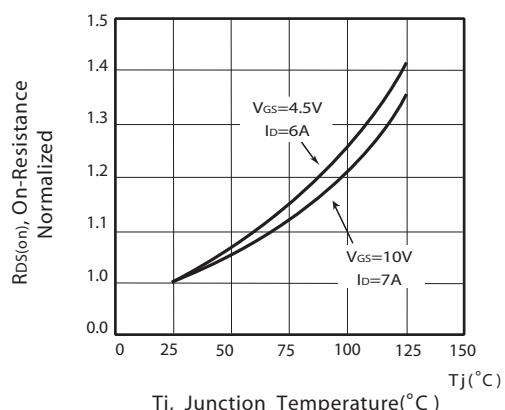


Figure 4. On-Resistance Variation with Drain Current and Temperature

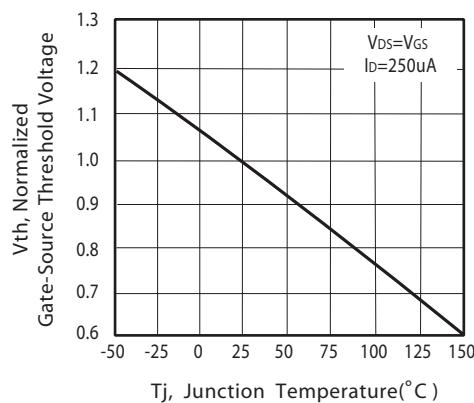


Figure 5. Gate Threshold Variation with Temperature

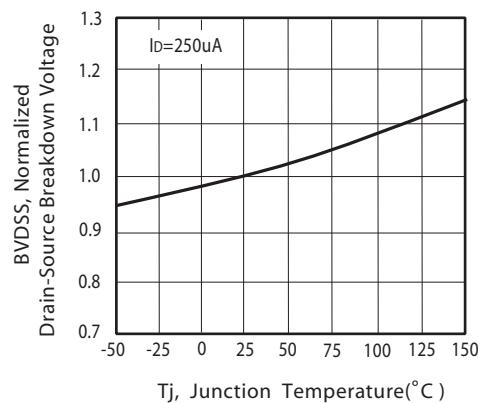


Figure 6. Breakdown Voltage Variation with Temperature

STM4460

Ver 1.0

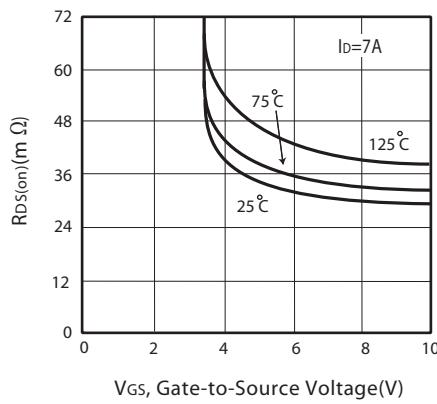


Figure 7. On-Resistance vs.
Gate-Source Voltage

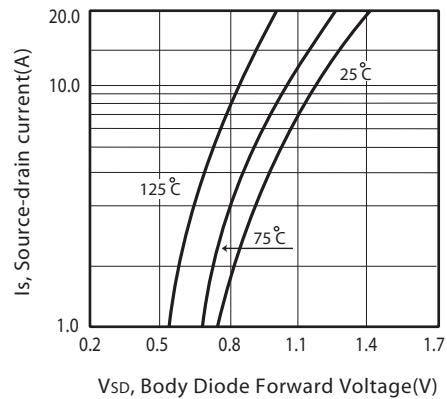


Figure 8. Body Diode Forward Voltage
Variation with Source Current

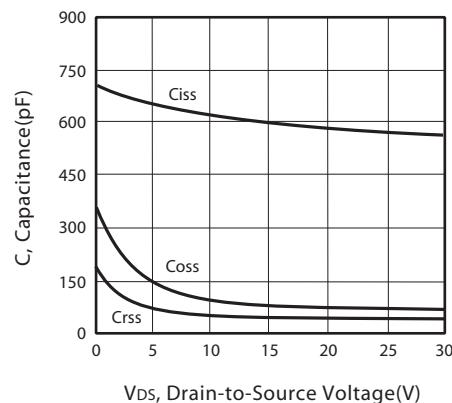


Figure 9. Capacitance

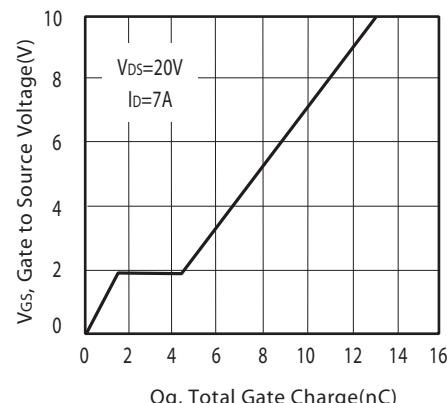


Figure 10. Gate Charge

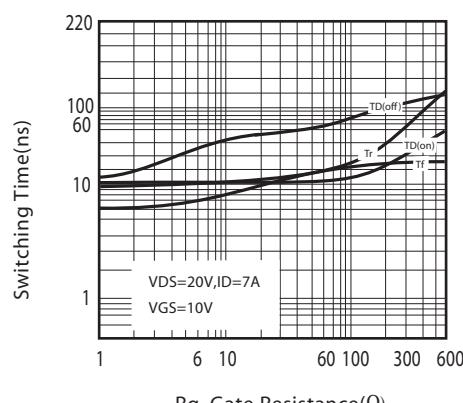


Figure 11. switching characteristics

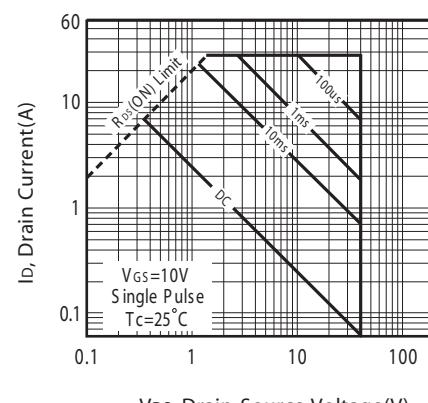
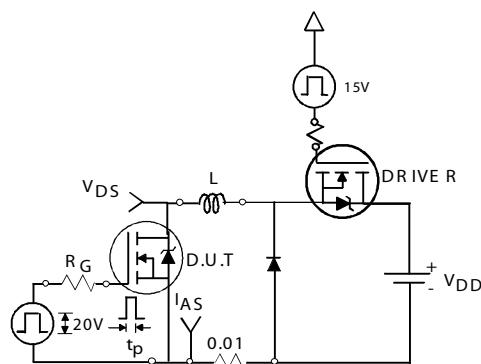


Figure 12. Maximum Safe Operating Area

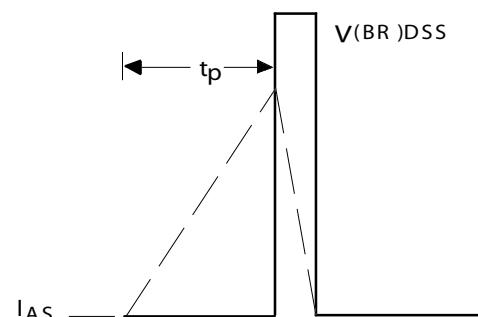
STM460

Ver 1.0



Unclamped Inductive Test Circuit

Figure 13a.



Unclamped Inductive Waveforms

Figure 13b.

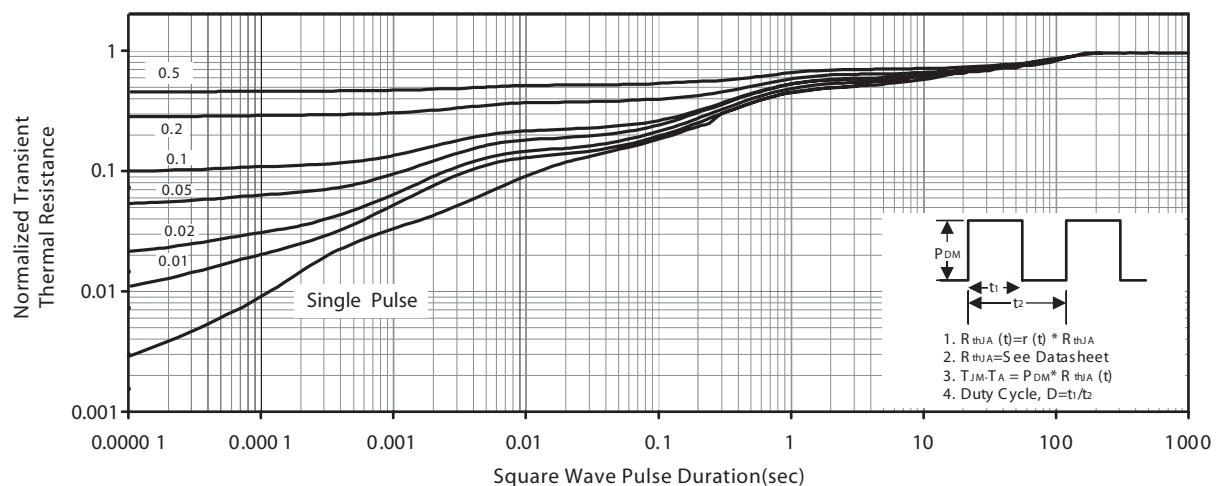
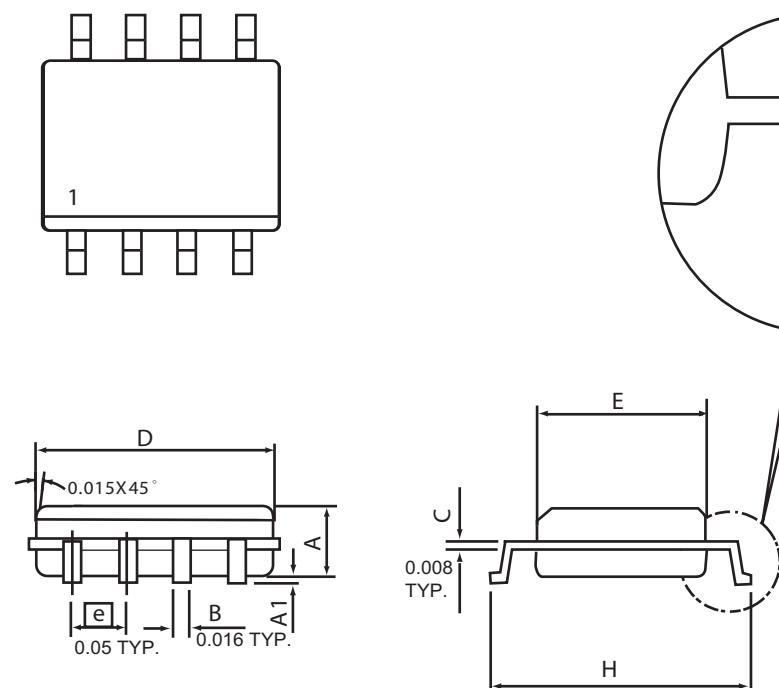


Figure 14. Normalized Thermal Transient Impedance Curve

Jun,18,2008

PACKAGE OUTLINE DIMENSIONS

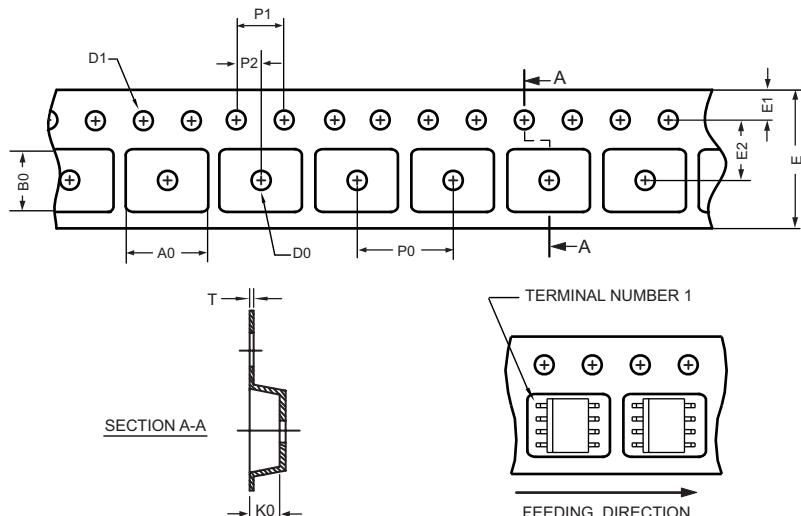
SO-8



SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.35	1.75	0.053	0.069
A1	0.10	0.25	0.004	0.010
D	4.80	4.98	0.189	0.196
E	3.81	3.99	0.150	0.157
H	5.79	6.20	0.228	0.244
L	0.41	1.27	0.016	0.050
θ	0°	8°	0°	8°

SO-8 Tape and Reel Data

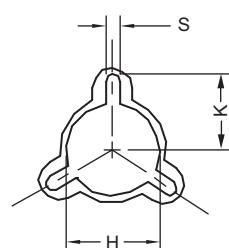
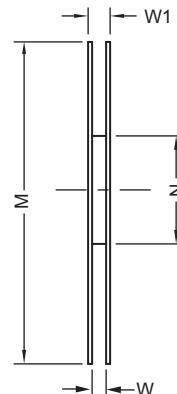
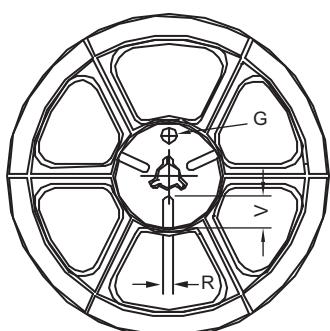
SO-8 Carrier Tape



unit:mm

PACKAGE	A0	B0	K0	D0	D1	E	E1	E2	P0	P1	P2	T
SOP 8N 150mil	6.50 ± 0.15	5.25 ± 0.10	2.10 ± 0.10	$\phi 1.5$ (MIN)	$\phi 1.55$ ± 0.10	12.0 $+0.3$ -0.1	1.75 ± 0.10	5.5 ± 0.10	8.0 ± 0.10	4.0 ± 0.10	2.0 ± 0.10	0.30 ± 0.013

SO-8 Reel



UNIT:mm

TAPE SIZE	REEL SIZE	M	N	W	W1	H	K	S	G	R	V
12 mm	$\phi 330$	330 ± 1	62 ± 1.5	12.4 $+0.2$	16.8 -0.4	$\phi 12.75$ $+0.15$	---	2.0 ± 0.15	---	---	---